



REV.	ECN NO.	REVISED	DATE

1.MATERIAL:

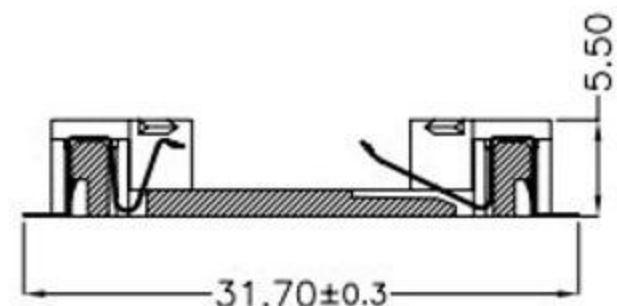
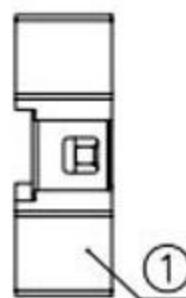
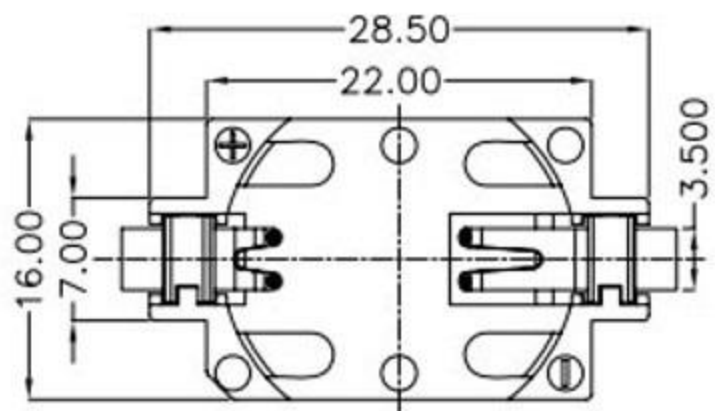
- a.HOUSING:LCP UL94V-0
- b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING:AU1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

- a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
- b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
- c.DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL
- d.OPERATING TEMPERATURE: -25°C~ +85°C

ORDERING INFORMATION

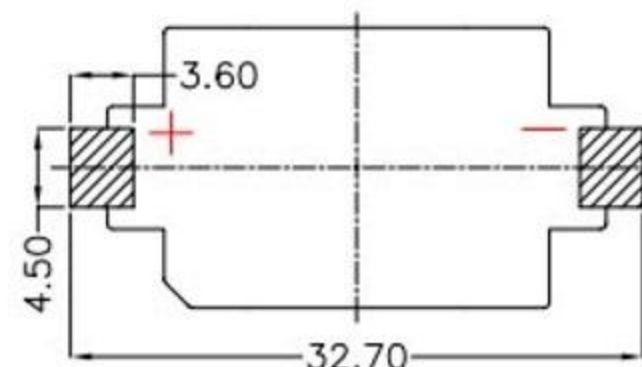


电池座系列

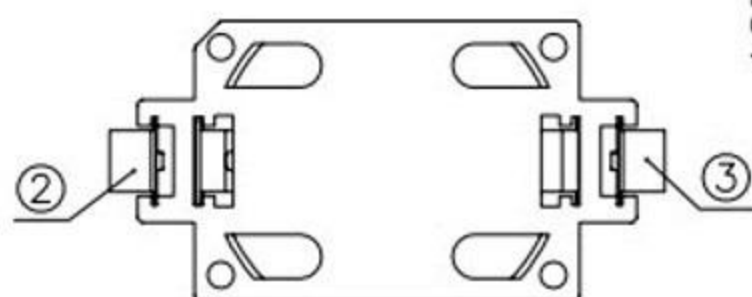
PLATING:
A-Au1u"
J-Ni100u"~120u"
K-Sn100u"~120u"

MATERIAL:
1A-PBT BLACK
1B-PA66 BLACK
2A-PPA BROWN
2B-PPA BLACK
3A-PPS BROWN
3B-PPS BLACK
4A-LCP WHITE
4B-LCP BLACK
5A-PA6T WHITE
5B-PA6T BLACK

SMT 180° TYPE



PCB Layout Diagram
Top View



UNLESS OTHERWISE SPECIFIED TOLERANCES				东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.			
DECIMALS: X: ±0.30 X.X: ±0.25 X.XX: ±0.20 X.XXX: ±0.10		ANGLES: X: ±1° X.X: ±0.5°		DSND	DATE	2017-07-11	TITLE:
WEIGHT: 1.49g		CHKD	DATE	2017-07-11	PART NO.:		
SHEET 1 OF 1		APVD	DATE	2017-07-11	DRAW NO.		
SCALE: 2:1		SIZE: A4		VIEW: ④ ⑤			
UNIT: mm		REV.: A/0		OBJECT: MY			

NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR
3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	LCP	WHITE